DATA SHEET : CKRF2430XS01

0.1 to 6.0GHz SP3T Switch for Bluetooth® and 802.11a/b/g/n

Features

- Control voltage :
  VC(H) = 1.8 to 5.0 V (3.0V TYP.)
  VC(L) = -0.2 to 0.2 V (0V TYP.)
- Low Insertion Loss :
  Lins = 0.50 dB TYP. @ f = 2.0 to 2.5 GHz
  Lins = 0.60 dB TYP. @ f = 4.9 to 6.0 GHz
- High Isolation :
  ISL = 28 dB TYP. @ f = 2.0 to 2.5 GHz
  ISL = 25 dB TYP. @ f = 4.9 to 6.0 GHz
- Handling power :
  Pin (1dB) = +31.0 dBm TYP.
  @ VC(H) = 3.0 V, VC(L) = 0 V

Package

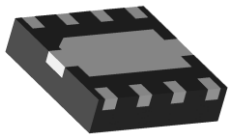
- 8-pin Thin SON (XS01) Package
  (1.5mm x 1.5mm x 0.37mm)

Description

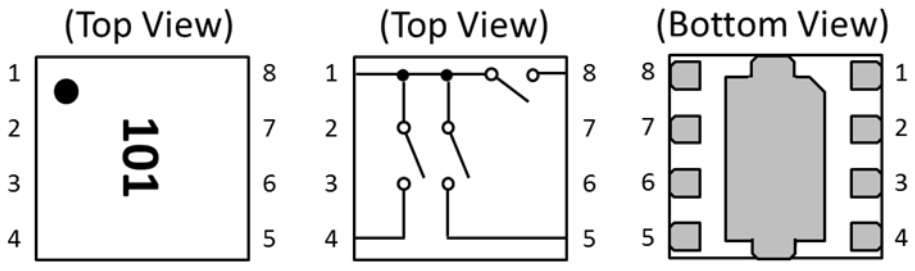
- The CKRF2430XS01 is a pHEMT GaAs SP3T (Single Pole Three Throw) switch. This device can operate frequency from 0.1GHz to 6.0GHz, having the low insertion loss and high isolation.

Applications

- Bluetooth
- Wireless LAN (IEEE 802.11 a/b/g/n)



Pin Configuration And Internal Block Diagram



Pin No.	Pin Name
1	RFC
2	GND
3	VC1
4	RF1
5	RF2
6	VC2
7	VC3
8	RF3

Remark Exposed pad : GND

Ordering Information

Part Number	Order Number	Package	Marking	Supplying Form
CKRF2430XS01-C2	CKRF2430XS01-C2-J	8-pin plastic TSON (Pb-Free)	101	・Embossed tape 8 mm wide ・Pin 1, 8 face the perforation side of the tape ・Qty 10 kpcs/reel

Absolute Maximum Ratings

(T_A = +25℃, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0[Note 1]	V
Input Power	P_{in}	+32.0[Note 2]	dBm
Operating Ambient Temperature	T_A	-45～+85	℃
Storage Temperature	T_{stg}	-55～+150	℃

Note 1. |VC1 - VC2|≦6.0V
2. 3.0V≦|VC1 – VC2|≦5.0V

Recommended Operating Range

(T_A=+25℃, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.1	-	6.0	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.0	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V

Truth Table

VC1	VC2	VC3	RFC-RF1	RFC-RF2	RFC-RF3
High	Low	Low	ON	OFF	OFF
Low	High	Low	OFF	ON	OFF
Low	Low	High	OFF	OFF	ON

Electrical Characteristics 1

(T_A=+25℃, VC(H)=3.0V, VC(L)=0V, DC Block Capacitance=8pF, Zo=50Ω, unless otherwise specified)

Parameter	Symbol	Path	Condition	MIN.	TYP.	MAX.	Unit
Insertion Loss	L_{INS}	RFC to RF1, 2, 3 (ON)	f=0.1GHz to 1.0GHz Note 1	---	0.40	0.55	dB
			f=1.0GHz to 2.0GHz Note 1	---	0.40	0.55	dB
			f=2.0GHz to 2.5GHz	---	0.50	0.65	dB
			f=2.5GHz to 4.9GHz	---	0.55	0.70	dB
			f=4.9GHz to 6.0GHz	---	0.60	0.80	dB
Isolation	ISL	RFC to RF1, 2, 3 (OFF)	f=0.1GHz to 1.0GHz Note 1	30	33	---	dB
			f=1.0GHz to 2.0GHz Note 1	27	30	---	dB
			f=2.0GHz to 2.5GHz	25	28	---	dB
			f=2.5GHz to 4.9GHz	23	28	---	dB
			f=4.9GHz to 6.0GHz	20	25	---	dB
Return Loss	RL	RFC to RF1, 2, 3 (ON)	f=0.1GHz to 1.0GHz Note 1	15	20	---	dB
			f=1.0GHz to 2.0GHz Note 1	15	20	---	dB
			f=2.0GHz to 2.5GHz	15	20	---	dB
			f=2.5GHz to 4.9GHz	15	20	---	dB
			f=4.9GHz to 6.0GHz	15	20	---	dB
0.1dB Loss Compression Input Power Note 2	$P_{in(-0.1dB)}$	RFC to RF1, 2, 3	f=2.5GHz	+25.0	+28.0	---	dBm
			f=6.0GHz	+25.0	+28.0	---	dBm
1dB Loss Compression Input Power Note 3	$P_{in(-1dB)}$	RFC to RF1, 2, 3	f=2.5GHz	+28.0	+31.0	---	dBm
			f=6.0GHz	+28.0	+31.0	---	dBm
3rd Order Input Intercept Point	IIP_3		f=2.5GHz, 2-tone 5MHz Spacing	---	+55	---	dBm
2nd Harmonics	2f0		f=2.5GHz, P_{in}=+22dBm	---	75	---	dBc
3rd Harmonics	3f0		f=2.5GHz, P_{in}=+22dBm	---	70	---	dBc
Switching Speed	T_{SW}		f=1.0GHz	---	80	---	ns
Switch Control Current	I_{CONT}		RF none	---	2	10	uA

Note 1. DC block capacitance = 330pF at f=0.1 to 2.0GHz

2. $P_{in(0.1dB)}$ is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

3. $P_{in(1dB)}$ is the measured input power level when the insertion loss increases 1dB more than that of the linear range.

Electrical Characteristics 2

(T_A=+25℃, VC(H)=1.8V, VC(L)=0V, DC Block Capacitance=8pF, Zo=50Ω, unless otherwise specified)

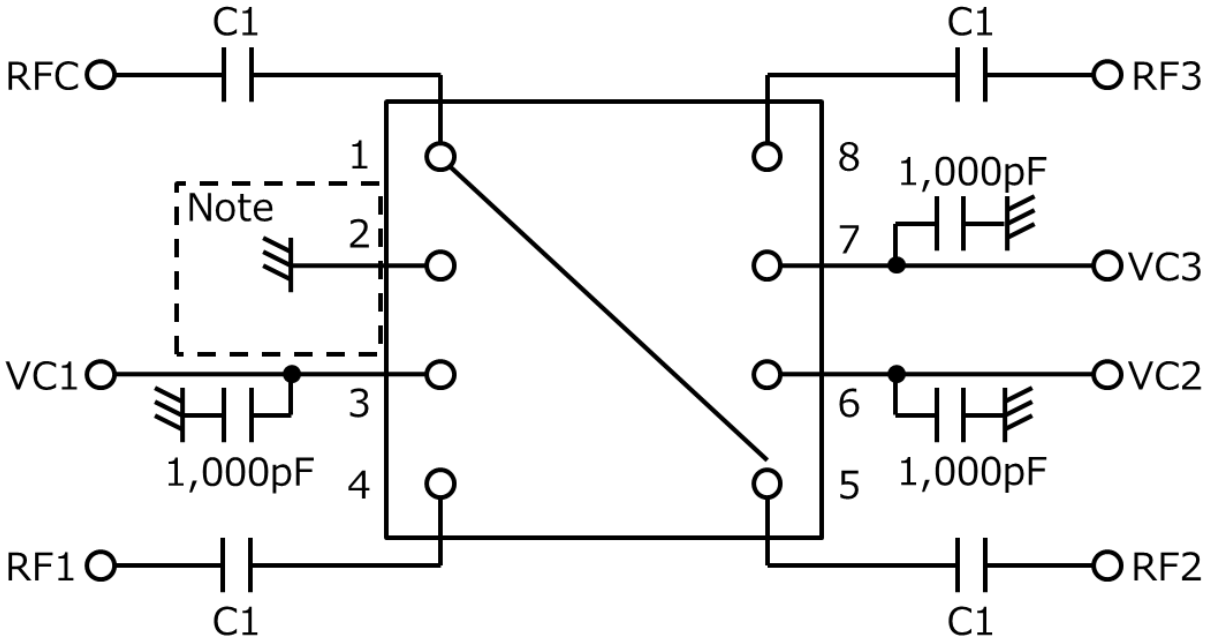
Parameter	Symbol	Path	Condition	MIN.	TYP.	MAX.	Unit
Insertion Loss	L_{INS}	RFC to RF1, 2, 3 (ON)	f=0.1GHz to 1.0GHz Note 1	---	0.40	0.55	dB
			f=1.0GHz to 2.0GHz Note 1	---	0.40	0.55	dB
			f=2.0GHz to 2.5GHz	---	0.50	0.65	dB
			f=2.5GHz to 4.9GHz	---	0.55	0.70	dB
			f=4.9GHz to 6.0GHz	---	0.60	0.80	dB
Isolation	ISL	RFC to RF1, 2, 3 (OFF)	f=0.1GHz to 1.0GHz Note 1	30	33	---	dB
			f=1.0GHz to 2.0GHz Note 1	27	30	---	dB
			f=2.0GHz to 2.5GHz	25	28	---	dB
			f=2.5GHz to 4.9GHz	23	28	---	dB
			f=4.9GHz to 6.0GHz	20	25	---	dB
Return Loss	RL	RFC to RF1, 2, 3 (ON)	f=0.1GHz to 1.0GHz Note 1	15	20	---	dB
			f=1.0GHz to 2.0GHz Note 1	15	20	---	dB
			f=2.0GHz to 2.5GHz	15	20	---	dB
			f=2.5GHz to 4.9GHz	15	20	---	dB
			f=4.9GHz to 6.0GHz	15	20	---	dB
0.1dB Loss Compression Input Power Note 2	$P_{in(-0.1dB)}$	RFC to RF1, 2, 3	f=2.5GHz	+19.0	+22.0	---	dBm
			f=6.0GHz	+18.0	+21.0	---	dBm
1dB Loss Compression Input Power Note 3	$P_{in(-1dB)}$	RFC to RF1, 2, 3	f=2.5GHz	+22.0	+25.0	---	dBm
			f=6.0GHz	+21.0	+24.0	---	dBm
3rd Order Input Intercept Point	IIP_3		f=2.5GHz, 2-tone 5MHz Spacing	---	+47	---	dBm
2nd Harmonics	2f0		f=2.5GHz, P_{in}=+22dBm	---	75	---	dBc
3rd Harmonics	3f0		f=2.5GHz, P_{in}=+22dBm	---	60	---	dBc
Switching Speed	T_{SW}		f=1.0GHz	---	150	---	ns
Switch Control Current	I_{CONT}		RF none	---	2	10	uA

Note 1. DC block capacitance = 330pF at f=0.1 to 2.0GHz

2. $P_{in(0.1dB)}$ is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

3. $P_{in(1dB)}$ is the measured input power level when the insertion loss increases 1dB more than that of the linear range.

Evaluation Circuit

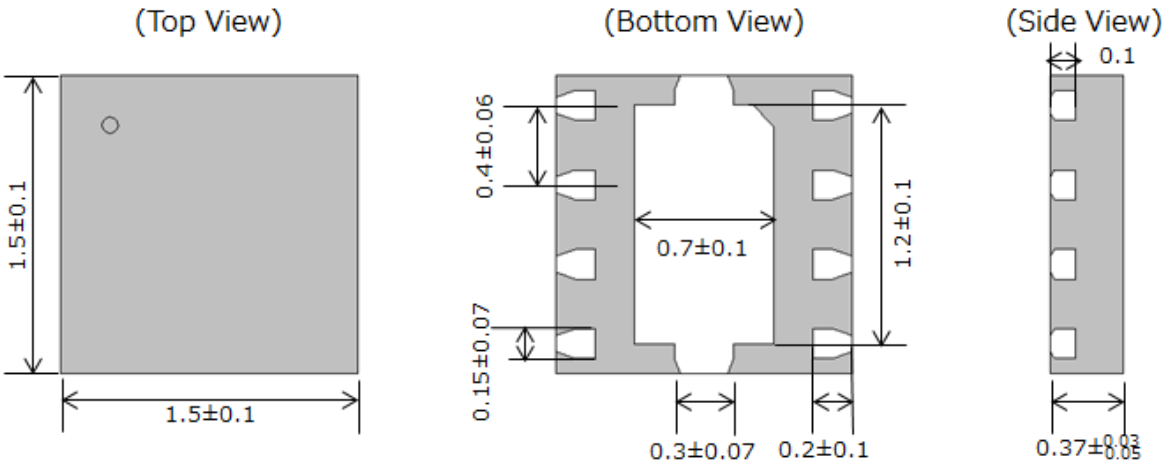


Note: It is recommended to connect the pin directly to the ground, or not to connect the pin to anything.

Remarks C1 : 0.1 to 2.0 GHz 330pF
: 2.0 to 6.0 GHz 8pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins. This device is used it is necessary to use DC Block Capacitance.

Package Dimensions



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- Do not dispose in fire or break up this product.
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- Do not lick the product or in any way allow it to enter the mouth.

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Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

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